

I^2C^{\otimes} CMOS 8 × 8 Unbuffered Analog Switch Array with Dual/Single Supplies

Data Sheet

FEATURES

I²C-compatible interface 3.4 MHz high speed I²C option 32-lead LFCSP_WQ (5 mm × 5 mm) **Double-buffered input logic** Simultaneous update of multiple switches Up to 300 MHz bandwidth Fully specified at dual ±5 V/single +12 V operation On resistance 35 Ω maximum Low quiescent current < 20 µA **Qualified for automotive applications**

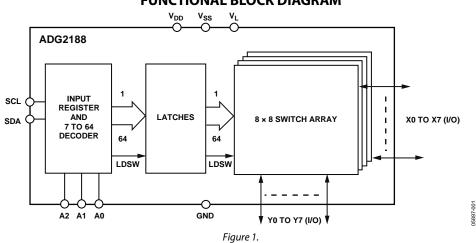
APPLICATIONS

AV switching in TV Automotive infotainment **AV** receivers ссти **Ultrasound applications KVM** switching **Telecom applications Test equipment/instrumentation PBX systems**

GENERAL DESCRIPTION

The ADG2188 is an analog cross point switch with an array size of 8×8 . The switch array is arranged so that there are eight columns by eight rows, for a total of 64 switch channels. The array is bidirectional, and the rows and columns can be configured as either inputs or outputs. Each of the 64 switches can be addressed and configured through the I²C-compatible interface. Standard, full speed, and high speed (3.4 MHz) I²C interfaces are supported. Any simultaneous switch combination is allowed. An additional feature of the ADG2188 is that switches can be updated simultaneously, using the LDSW command. In addition, a RESET option allows all of the switch channels to be reset/off. At power on, all switches are in the off condition. The device is packaged in a 32-lead, $5 \text{ mm} \times 5 \text{ mm} \text{ LFCSP}_WQ$.

ADG2188



FUNCTIONAL BLOCK DIAGRAM

Document Feedback

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REVISION HISTORY

| 7/2017—Rev. A to Rev. B | |
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| Changes to Figure 3 | 10 |
| Changes to RESET/Power-On Reset Section | 18 |
| Updated Outline Dimensions | 27 |
| Changes to Ordering Guide | 27 |

2/2015-Rev. 0 to Rev. A

| Changed NC Pins to DNC Pins | 10 |
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| Updated Outline Dimensions | 27 |
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4/2006—Revision 0: Initial Version

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SPECIFICATIONS

 V_{DD} = 12 V ± 10%, V_{SS} = 0 V, V_L = 5 V, GND = 0 V, all specifications T_{MIN} to T_{MAX} , unless otherwise noted.¹

Table 1.

| | B Version | | Y | Y Version | | |
|---|------------------|----------------|-------|----------------|---------|--|
| - | | –40°C to | | –40°C to | | |
| Parameter | +25°C | +85°C | +25°C | +125°C | Unit | Test Conditions/Comments |
| ANALOG SWITCH | | | | | | |
| Analog Signal Range | | $V_{DD} - 2 V$ | | $V_{DD} - 2 V$ | V max | |
| On Resistance, R _{on} | 30 | | 30 | | Ω typ | $V_{DD} = 10.8 \text{ V}, V_{IN} = 0 \text{ V}, I_S = -10 \text{ mA}$ |
| | 35 | 40 | 35 | 42 | Ωmax | |
| | 32 | | 32 | | Ω typ | $V_{DD} = 10.8 \text{ V}, V_{IN} = 1.4 \text{ V}, I_{S} = -10 \text{ mA}$ |
| | 37 | 42 | 37 | 47 | Ωmax | |
| | 45 | | 45 | | Ω typ | $V_{DD} = 10.8 \text{ V}, V_{IN} = 5.4 \text{ V}, I_{S} = -10 \text{ mA}$ |
| | 50 | 57 | 50 | 62 | Ωmax | |
| On Resistance Matching | 4.5 | | 4.5 | | Ωtyp | $V_{DD} = 10.8 V, V_{IN} = 0 V, I_s = -10 mA$ |
| Between Channels, ΔR_{ON} | 8 | 9 | 8 | 10 | Ωmax | |
| On Resistance Flatness, R _{FLAT(ON)} | 2.3 | | 2.3 | | Ω typ | $V_{DD} = 10.8 \text{ V}, V_{IN} = 0 \text{ V}$ to $1.4 \text{ V}, I_S = -10 \text{ mA}$ |
| | 3.5 | 4 | 3.5 | 5 | Ωmax | |
| | 14.5 | | 14.5 | | Ω typ | $V_{DD} = 10.8 V$, $V_{IN} = 0 V$ to 5.4 V, $I_S = -10 mA$ |
| | 18 | 20 | 18 | 22 | Ωmax | |
| LEAKAGE CURRENTS | | | | | | $V_{DD} = 13.2 V$ |
| Channel Off Leakage, IOFF | ±0.03 | | ±0.03 | | μA typ | $V_X = 7 V/1 V$, $V_Y = 1 V/7 V$ |
| Channel On Leakage, Ion | ±0.03 | | ±0.03 | | μA typ | $V_X = V_Y = 1 V \text{ or } 7 V$ |
| DYNAMIC CHARACTERISTICS ² | | | | | | |
| Coff | 11 | | 11 | | pF typ | |
| Con | 18.5 | | 18.5 | | pF typ | |
| ton | 170 | | 170 | | ns typ | $R_L = 300 \Omega$, $C_L = 35 pF$ |
| | 185 | 190 | 185 | 195 | ns max | |
| toff | 210 | | 210 | | ns typ | $R_L = 300 \Omega$, $C_L = 35 pF$ |
| | 250 | 255 | 250 | 260 | ns max | |
| THD + N | 0.04 | | 0.04 | | % typ | $R_L = 10 \text{ k}\Omega$, f = 20 Hz to 20 kHz, V _s = 1 V p-p |
| PSRR | | | 90 | | dB typ | f = 20 kHz; without decoupling; see Figure 24 |
| –3 dB Bandwidth | 210 | | 210 | | MHz typ | Individual inputs to outputs |
| | 16.5 | | 16.5 | | MHz typ | 8 inputs to 1 output |
| Off Isolation | -69 | | -69 | | dB typ | $R_L = 75 \Omega$, $C_L = 5 pF$, $f = 5 MHz$ |
| Channel-to-Channel Crosstalk | | | | | | $R_L = 75 \Omega$, $C_L = 5 pF$, $f = 5 MHz$ |
| Adjacent Channels | -63 | | -63 | | dB typ | |
| Nonadjacent Channels | -76 | | -76 | | dB typ | |
| Differential Gain | 0.4 | | 0.4 | | % typ | $R_L = 75 \Omega$, $C_L = 5 pF$, $f = 5 MHz$ |
| Differential Phase | 0.6 | | 0.6 | | ° typ | $R_L = 75 \Omega, C_L = 5 pF, f = 5 MHz$ |
| Charge Injection | -3.5 | | -3.5 | | pC typ | $V_{s} = 4 V, R_{s} = 0 \Omega, C_{L} = 1 nF$ |
| LOGIC INPUTS (Ax, RESET) ² | | | | | | |
| Input High Voltage, V _{INH} | | 2.0 | | 2.0 | V min | |
| Input Low Voltage, V _{INL} | | 0.8 | | 0.8 | V max | |
| Input Leakage Current, I_{IN} | 0.005 | | 0.005 | | μA typ | |
| | | ±1 | | ±1 | µA max | |
| Input Capacitance, C _{IN} | 7 | | 7 | | pF typ | |

| | B Version | | Y Version | | | |
|--|-----------|----------------------|-----------|-------------|--------|--|
| | | –40°C to | | –40°C to | | |
| Parameter | +25°C | +85°C | +25°C | +125°C | Unit | Test Conditions/Comments |
| LOGIC INPUTS (SCL, SDA) ² | | | | | | |
| Input High Voltage, V _{INH} | | 0.7 VL | | 0.7 VL | V min | |
| | | $V_L + 0.3$ | | $V_L + 0.3$ | V max | |
| Input Low Voltage, VINL | | -0.3 | | -0.3 | V min | |
| | | 0.3 VL | | 0.3 VL | V max | |
| Input Leakage Current, I _{IN} | 0.005 | | 0.005 | | μA typ | $V_{\text{IN}} = 0 \text{ V to } V_{\text{L}}$ |
| | | ±1 | | ±1 | μA max | |
| Input Hysteresis | | $0.05 V_{\text{L}}$ | | 0.05 VL | V min | |
| Input Capacitance, C _{IN} | 7 | | 7 | | pF typ | |
| LOGIC OUTPUT (SDA) ² | | | | | | |
| Output Low Voltage, V _{OL} | | 0.4 | | 0.4 | V max | $I_{SINK} = 3 \text{ mA}$ |
| | | 0.6 | | 0.6 | V max | $I_{SINK} = 6 \text{ mA}$ |
| Floating State Leakage Current | | ±1 | | ±1 | μA max | |
| POWER REQUIREMENTS | | | | | | |
| ldd | 0.05 | | 0.05 | | μA typ | Digital inputs = $0 V \text{ or } V_{L}$ |
| | | 1 | | 1 | μA max | |
| lss | 0.05 | | 0.05 | | μA typ | Digital inputs = $0 V \text{ or } V_{L}$ |
| | | 1 | | 1 | μA max | |
| l. | | | | | | Digital inputs = $0 V \text{ or } V_{L}$ |
| Interface Inactive | 0.3 | | 0.3 | | μA typ | |
| | | 2 | | 2 | μA max | |
| Interface Active: 400 kHz fscl | 0.1 | | 0.1 | | mA typ | |
| | | 0.2 | | 0.2 | mA max | |
| Interface Active: 3.4 MHz fscl | 0.4 | | 0.4 | | mA typ | -HS model only |
| | | 1.2 | | 1.7 | mA max | |

 1 Temperature range is as follows: B version: –40°C to +85°C; Y version: –40°C to +125°C. 2 Guaranteed by design, not subject to production test.

Data Sheet

 V_{DD} = +5 V ± 10% , V_{SS} = -5 V ± 10% , V_L = 5 V, GND = 0 V, all specifications T_{MIN} to T_{MAX} , unless otherwise noted.¹

Table 2.

| ±25°C | | +25°C | | Unit | Test Conditions/Comments |
|----------|---|--|--|---|--|
| 125 C | 105 C | 125 0 | 1125 C | onic | |
| | | | Vpp – 2 V | V max | |
| 34 | | 34 | VDD 2V | | $V_{DD} = +4.5 V$, $V_{SS} = -4.5 V$, $V_{IN} = V_{SS}$, $I_S = -10 \text{ mA}$ |
| | 45 | | 50 | | |
| | 15 | | 50 | | $V_{DD} = +4.5 V, V_{SS} = -4.5 V, V_{IN} = 0 V, I_{S} = -10 mA$ |
| | 65 | | 70 | | |
| | 05 | | , 0 | | $V_{DD} = +4.5 V, V_{SS} = -4.5 V, V_{IN} = +1.4 V, I_{S} = -10 \text{ mA}$ |
| | 85 | | 95 | | |
| | 05 | - | 22 | | $V_{DD} = +4.5 V, V_{SS} = -4.5 V, V_{IN} = V_{SS}, I_S = -10 mA$ |
| | 9 | | 10 | | |
| | , | | 10 | | $V_{DD} = +4.5 V$, $V_{SS} = -4.5 V$, $V_{IN} = V_{SS}$ to 0 V, $I_{S} = -10 m$. |
| | 23 | | 25 | | |
| 20 34 | 23 | 20 34 | 23 | Ωtyp | $V_{DD} = +4.5 \text{ V}, V_{SS} = -4.5 \text{ V}, V_{IN} = V_{SS} \text{ to } +1.4 \text{ V},$ |
| 42 | 45 | 42 | 48 | O max | $I_s = -10 \text{ mA}$ |
| 14 | 15 | 12 | 10 | 32 110A | $V_{DD} = 5.5 V, V_{SS} = 5.5 V$ |
| +0.03 | | +0.03 | | uA tvp | $V_x = +4.5 V/-2 V, V_y = -2 V/+4.5 V$ |
| | | | | | $V_x = V_y = -2 V \text{ or } +4.5 V$ |
| 10.05 | | 10.05 | | μπιγρ | |
| 6 | | 6 | | pF typ | |
| | | | | | |
| | | | | | $R_L = 300 \Omega, C_L = 35 pF$ |
| | 215 | | 220 | <i>·</i> · · | |
| | 215 | | 220 | | $R_L = 300 \Omega, C_L = 35 pF$ |
| | 255 | | 260 | <i>,</i> , | n = 300 12, Cl = 35 pi |
| | 233 | | 200 | | $R_L = 10 \text{ k}\Omega$, f = 20 Hz to 20 kHz, Vs = 1 V p-p |
| 0.04 | | | | | f = 20 kHz; without decoupling; see Figure 24 |
| 300 | | | | | Individual inputs to outputs |
| | | | | | 8 inputs to 1 output |
| | | - | | | $R_L = 75 \Omega$, $C_L = 5 pF$, $f = 5 MHz$ |
| -00 | | -04 | | ubtyp | $R_L = 75 \Omega$, $C_L = 5 pF$, $f = 5 MHz$ |
| 67 | | 67 | | dP two | $R_{L} = 73 \Omega_{2}, C_{L} = 3 \text{ pr}, 1 = 3 \text{ MHz}$ |
| | | | | | |
| | | | | | $R_L = 75 \Omega$, $C_L = 5 pF$, $f = 5 MHz$ |
| | | | | | $R_L = 75 \Omega$, $C_L = 5 pF$, $I = 5 MHZ$ $R_L = 75 \Omega$, $C_L = 5 pF$, $f = 5 MHZ$ |
| | | | | | $R_L = 75 \Omega_2, C_L = 5 \text{ pr}, T = 5 \text{ MHZ}$ $V_S = 0 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF}$ |
| _J | | د | | he rìb | vs = 0 v, ns = 0 s2, CL = 1 m |
| | 2.0 | | 2.0 | Vmin | |
| | | | | | |
| 0.005 | 0.0 | 0.005 | 0.0 | | |
| 0.005 | +1 | 0.005 | +1 | | |
| 7 | ± 1 | 7 | <u>- 1</u> | | |
| , | | , | | P1 (3P | |
| | 0.7.1/ | | 071/ | Vmin | |
| | | | | | |
| | v _L + 0.5 -0.3 | | v∟ + 0.5 –0.3 | V min | |
| | -0.5 | 1 | -0.5 | V 111111 | |
| | | | 031/ | Vmay | |
| 0.005 | $0.3V_L$ | 0.005 | $0.3 V_L$ | V max µA typ | $V_{IN} = 0 V \text{ to } V_L$ |
| | +25°C 34 40 50 55 66 75 4.5 8 17 20 | $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | +25°C +40°C to +85°C +25°C 34 4 5 34 45 34 40 50 50 55 65 55 66 75 66 75 85 75 4.5 8 17 20 23 17 20 23 20 34 45 42 42 45 42 45 8 17 20 23 20 34 17 20 50 5 66 9.5 170 20 42 45 42 403 17 20 50 215 200 210 255 200 210 250 300 18 64 18 -66 15 15 1.5 1.5 1.5 1.5 < | -40°C to -40°C to -40°C to 34 34 34 34 40 50 34 40 50 50 50 70 55 65 55 70 66 66 75 85 75 4.5 75 95 70 66 75 85 75 95 4.5 75 95 10 17 17 20 23 20 25 34 17 20 23 34 10 170 203 20 25 20 20 170 70 170 20 220 20 170 215 200 220 20 210 215 250 260 20 250 255 250 260 20 18 -64 -14 -14 -14 -79 <t< td=""><td>-40°C to +25°C -40°C to +25°C -40°C to +125°C Junit 34 VDD - 2V Vmax Atyp 34 40 50 Numax 40 40 50 Numax 50 50 70 Atyp 50 55 70 Atyp 55 65 55 95 Atyp 66 75 95 Atyp 75 85 75 95 Atyp 4.5 10 Atyp Atyp 75 92 Atyp Atyp 17 20 23 20 25 Atyp 203 21 42 48 Atyp 170 45 75 Presson Atyp 170 200 215 Atyp Atyp 170 215 200 220 Nsmax 170 215 200 220 Nsmax 170 215 250</td></t<> | -40°C to +25°C -40°C to +25°C -40°C to +125°C Junit 34 VDD - 2V Vmax Atyp 34 40 50 Numax 40 40 50 Numax 50 50 70 Atyp 50 55 70 Atyp 55 65 55 95 Atyp 66 75 95 Atyp 75 85 75 95 Atyp 4.5 10 Atyp Atyp 75 92 Atyp Atyp 17 20 23 20 25 Atyp 203 21 42 48 Atyp 170 45 75 Presson Atyp 170 200 215 Atyp Atyp 170 215 200 220 Nsmax 170 215 200 220 Nsmax 170 215 250 |

| | B Version | | YV | ersion | | |
|--|------------------|-------------------|-------|--------------------|--------|--|
| Parameter | +25°C | –40°C to +85°C | +25°C | –40°C to +125°C | Unit | Test Conditions/Comments |
| Input Hysteresis | | 0.05 VL | | $0.05 V_L$ | V min | |
| Input Capacitance, C _{IN} | 7 | | 7 | | pF typ | |
| LOGIC OUTPUT (SDA) ² | | | | | | |
| Output Low Voltage, Vol | | 0.4 | | 0.4 | V max | I _{SINK} = 3 mA |
| | | 0.6 | | 0.6 | V max | I _{SINK} = 6 mA |
| Floating State Leakage Current | | ±1 | | ±1 | μA max | |
| POWER REQUIREMENTS | | | | | | |
| lod | 0.05 | | 0.005 | | μA typ | Digital inputs = $0 V \text{ or } V_L$ |
| | | 1 | | 1 | μA max | |
| lss | 0.05 | | 0.005 | | μA typ | Digital inputs = $0 V \text{ or } V_L$ |
| | | 1 | | 1 | μA max | |
| lı. | | | | | | Digital inputs = $0 V \text{ or } V_L$ |
| Interface Inactive | 0.3 | | 0.3 | | μA typ | |
| | | 2 | | 2 | μA max | |
| Interface Active: 400 kHz fscl | 0.1 | | 0.1 | | mA typ | |
| | | 0.1 | | 0.1 | mA max | |
| Interface Active: 3.4 MHz f _{SCL} | 0.4 | | 0.4 | | mA typ | -HS model only |
| | | 0.3 | | 0.3 | mA max | |

 1 Temperature range is as follows: B version: –40°C to +85°C; Y version: –40°C to +125°C. 2 Guaranteed by design, not subject to production test.

I²C TIMING SPECIFICATIONS

 $V_{DD} = 5 V$ to 12 V; $V_{SS} = -5 V$ to 0 V; $V_L = 5 V$; GND = 0 V; $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted (see Figure 2).

| Table | 3. |
|-------|----|
| raute | э. |

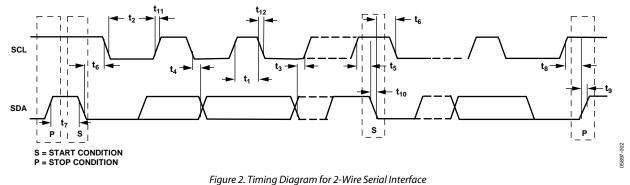
| | | ADG2188 Limit at T _{MIN} , T _{MAX} | | ин, Тмах | |
|------------------------|--|--|------|----------|--|
| Parameter ¹ | Test Conditions/Comments | Min | Max | Unit | Description |
| f _{scl} | Standard mode | | 100 | kHz | Serial clock frequency |
| | Fast mode | | 400 | kHz | |
| | High speed mode ² | | | | |
| | $C_B = 100 \text{ pF} \text{ maximum}$ | | 3.4 | MHz | |
| | $C_B = 400 \text{ pF} \text{ maximum}$ | | 1.7 | MHz | |
| t1 | Standard mode | 4 | | μs | tніgн, SCL high time |
| | Fast mode | 0.6 | | μs | |
| | High speed mode ² | | | | |
| | $C_B = 100 \text{ pF} \text{ maximum}$ | 60 | | ns | |
| | $C_B = 400 \text{ pF} \text{ maximum}$ | 120 | | ns | |
| t ₂ | Standard mode | 4.7 | | μs | tLOW, SCL low time |
| | Fast mode | 1.3 | | μs | |
| | High speed mode ² | | | | |
| | $C_B = 100 \text{ pF} \text{ maximum}$ | 160 | | ns | |
| | $C_B = 400 \text{ pF} \text{ maximum}$ | 320 | | ns | |
| t ₃ | Standard mode | 250 | | ns | t _{su;DAT} , data setup time |
| | Fast mode | 100 | | ns | |
| | High speed mode ² | 10 | | ns | |
| t4 ³ | Standard mode | 0 | 3.45 | μs | t _{HD;DAT} , data hold time |
| | Fast mode | 0 | 0.9 | μs | |
| | High speed mode ² | | | | |
| | $C_B = 100 \text{ pF} \text{ maximum}$ | 0 | 70 | ns | |
| | $C_B = 400 \text{ pF} \text{ maximum}$ | 0 | 150 | ns | |
| t₅ | Standard mode | 4.7 | | μs | t _{SU;STA} , setup time for a repeated start condition |
| | Fast mode | 0.6 | | μs | |
| | High speed mode ² | 160 | | ns | |
| t ₆ | Standard mode | 4 | | μs | t _{HD;STA} , hold time for a (repeated) start condition |
| | Fast mode | 0.6 | | μs | |
| | High speed mode ² | 160 | | ns | |
| t7 | Standard mode | 4.7 | | μs | $t_{\mbox{\scriptsize BUF}},$ bus free time between a stop and a start condition |
| | Fast mode | 1.3 | | μs | |
| t8 | Standard mode | 4 | | μs | t _{su;sto} , setup time for a stop condition |
| | Fast mode | 0.6 | | μs | |
| | High speed mode ² | 160 | | ns | |
| t9 | Standard mode | | 1000 | ns | t _{RDA} , rise time of SDA signal |
| | Fast mode | 20 + 0.1 C _B | 300 | ns | |
| | High speed mode ² | | | | |
| | $C_B = 100 \text{ pF} \text{ maximum}$ | 10 | 80 | ns | |
| | $C_B = 400 \text{ pF} \text{ maximum}$ | 20 | 160 | ns | |
| t ₁₀ | Standard mode | | 300 | ns | t _{FDA} , fall time of SDA signal |
| | Fast mode | 20 + 0.1 C _B | 300 | ns | |
| | High speed mode ² | | | | |
| | $C_B = 100 \text{ pF} \text{ maximum}$ | 10 | 80 | ns | |
| | $C_B = 400 \text{ pF} \text{ maximum}$ | 20 | 160 | ns | |

| | | ADG2188 L | imit at T _№ | IIN, TMAX | |
|---|--|-------------------------|------------------------|-----------|--|
| Parameter ¹ Test Conditions/Comments | Parameter ¹ | Min | Мах | Unit | Description |
| t ₁₁ | Standard mode | | 1000 | ns | t _{RCL} , rise time of SCL signal |
| | Fast mode | $20 + 0.1 C_B$ | 300 | ns | |
| | High speed mode ² | | | | |
| | $C_B = 100 \text{ pF} \text{ maximum}$ | 10 | 40 | ns | |
| | $C_B = 400 \text{ pF} \text{ maximum}$ | 20 | 80 | ns | |
| t _{11A} | Standard mode | | 1000 | ns | t _{RCL1} , rise time of SCL signal after a repeated start condition |
| | Fast mode | 20 + 0.1 C _B | 300 | ns | and after an acknowledge bit |
| | High speed mode ² | | | | |
| | $C_B = 100 \text{ pF} \text{ maximum}$ | 10 | 80 | ns | |
| | $C_B = 400 \text{ pF} \text{ maximum}$ | 20 | 160 | ns | |
| t ₁₂ | Standard mode | | 300 | ns | t _{FCL} , fall time of SCL signal |
| | Fast mode | 20 + 0.1 C _B | 300 | ns | |
| | High speed mode ² | | | | |
| | $C_B = 100 \text{ pF} \text{ maximum}$ | 10 | 40 | ns | |
| | $C_B = 400 \text{ pF} \text{ maximum}$ | 20 | 80 | ns | |
| t _{SP} | Fast mode | 0 | 50 | ns | Pulse width of suppressed spike |
| | High speed mode ² | 0 | 10 | ns | |

¹ Guaranteed by initial characterization. All values measured with input filtering enabled. C_B refers to capacitive load on the bus line; t_R and t_F are measured between 0.3 V_{DD} and 0.7 V_{DD} .

² High speed I²C is available only in -HS models
³ A device must provide a data hold time for SDA to bridge the undefined region of the SCL falling edge.

TIMING DIAGRAM



ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}C$, unless otherwise noted.

Table 4.

| Parameter | Rating |
|---|--|
| V _{DD} to V _{SS} | 15 V |
| V _{DD} to GND | –0.3 V to +15 V |
| Vss to GND | +0.3 V to -7 V |
| V₋ to GND | –0.3 V to +7 V |
| Analog Inputs | V_{SS} – 0.3 V to V_{DD} + 0.3 V |
| Digital Inputs | -0.3 V to V _L + 0.3 V or 30 mA, whichever occurs first |
| Continuous Current | |
| 10 V on Input; Single Input Connected to Single Output | 65 mA |
| 1 V on Input; Single Input Connected to Single Output | 90 mA |
| 10 V on Input; Eight Inputs Connected to Eight Outputs | 25 mA |
| Operating Temperature Range | |
| Industrial (B Version) | –40°C to +85°C |
| Automotive (Y Version) | –40°C to +125°C |
| Storage Temperature Range | –65°C to +150°C |
| Junction Temperature | 150°C |
| 32-Lead LFCSP_WQ | |
| θ_{JA} Thermal Impedance | 108.2°C/W |
| Reflow Soldering (Pb Free) | |
| Peak Temperature | 260°C (+0/–5) |
| Time at Peak Temperature | 10 sec to 40 sec |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

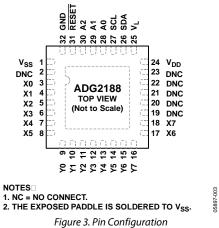
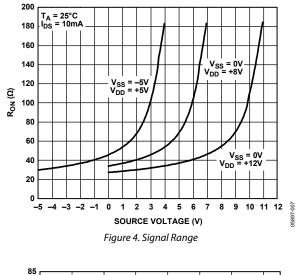


Table 5. Pin Function Descriptions¹

| Pin No. | Mnemonic | Description |
|-------------|-----------------|---|
| 1 | V _{SS} | Negative Power Supply in a Dual-Supply Application. For single-supply applications, this pin must be tied to GND. |
| 2, 19 to 23 | DNC | Do No Connect. |
| 3 to 8, | X0 to X7 | Can be inputs or outputs. |
| 17, 18 | | |
| 9 to 16 | Y0 to Y7 | Can be inputs or outputs. |
| 24 | V _{DD} | Positive Power Supply Input. |
| 25 | VL | Logic Power Supply Input. |
| 26 | SDA | Digital I/O. Bidirectional open drain data line. External pull-up resistor required. |
| 27 | SCL | Digital Input, Serial Clock Line. Open drain input that is used in conjunction with SDA to clock data into the device. External pull-up resistor required. |
| 28 | A0 | Logic Input. Address pin that sets the least significant bit of the 7-bit slave address. |
| 29 | A1 | Logic Input. Address pin that sets the second least significant bit of the 7-bit slave address. |
| 30 | A2 | Logic Input. Address pin that sets the third least significant bit of the 7-bit slave address. |
| 31 | RESET | Active Low Logic Input. When this pin is low, all switches are open, and appropriate registers are cleared to 0. |
| 32 | GND | Ground. Reference point for all circuitry on the ADG2188. |
| | EPAD | Exposed Paddle. The exposed paddle is soldered to Vss. |

 1 It is recommended that the exposed paddle be soldered to V_{ss} to improve heat dissipation and crosstalk.

TYPICAL PERFORMANCE CHARACTERISTICS



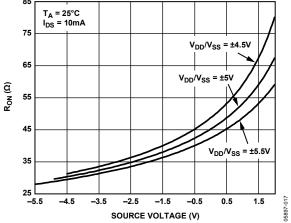
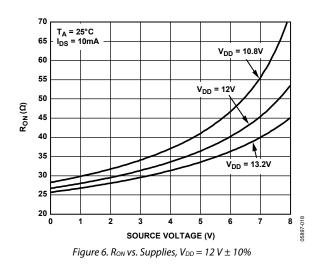


Figure 5. R_{ON} vs. Source Voltage, Dual ±5 V Supplies



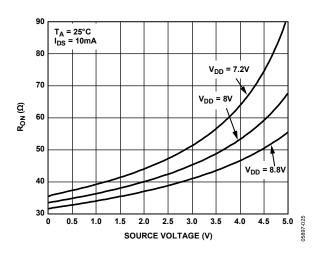


Figure 7. R_{ON} vs. Source Voltage, $V_{DD} = 8 V \pm 10\%$

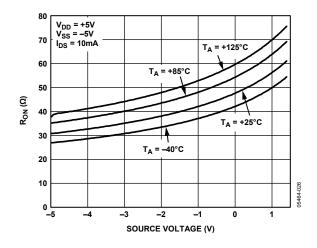
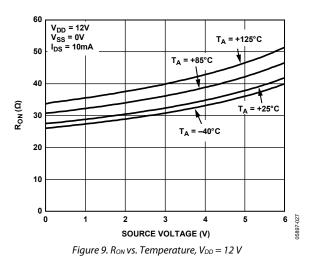


Figure 8. R_{ON} vs. Temperature, Dual ± 5 V Supplies



100

100

120 0110-111

05897-012

120

11 05897-030

9

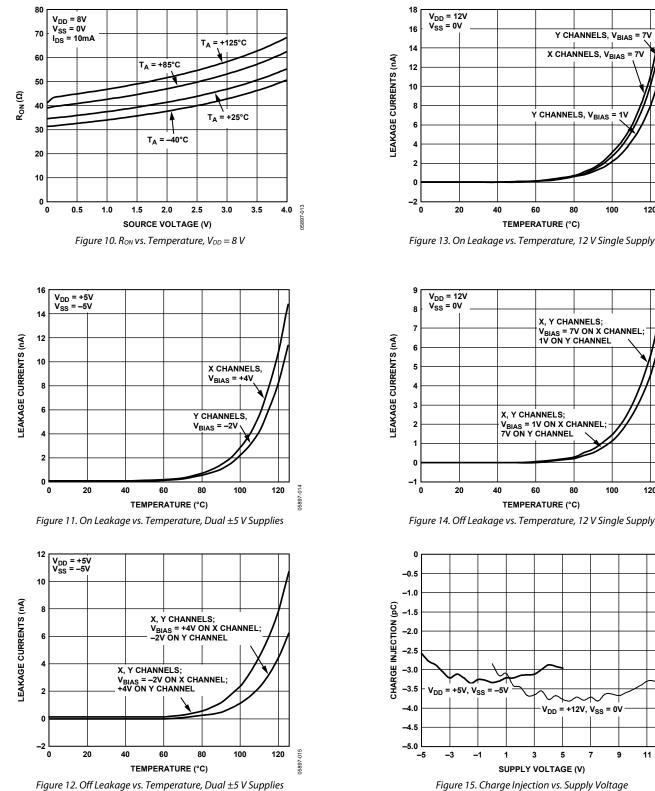
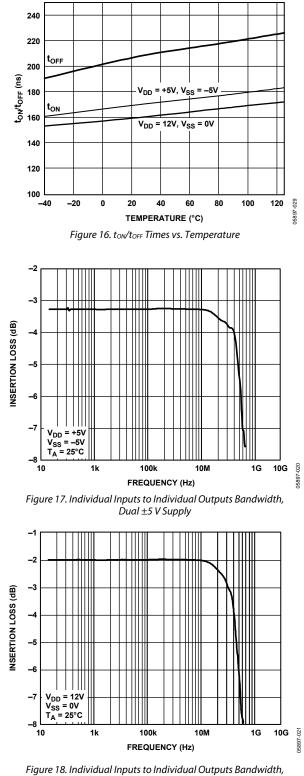


Figure 15. Charge Injection vs. Supply Voltage



12 V Single Supply

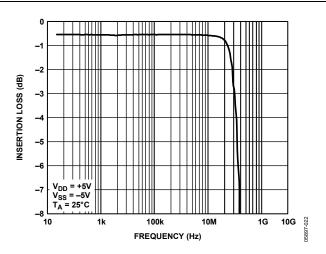


Figure 19. One Input to Eight Outputs Bandwidth, ± 5 V Dual Supply

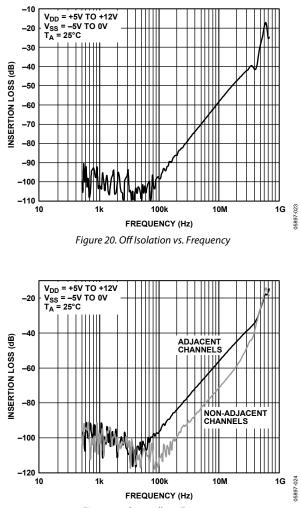


Figure 21. Crosstalk vs. Frequency

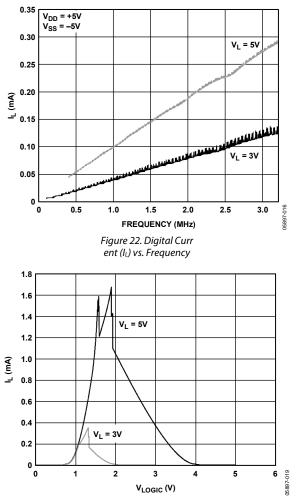
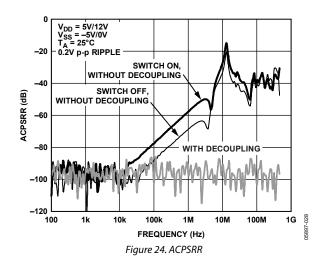
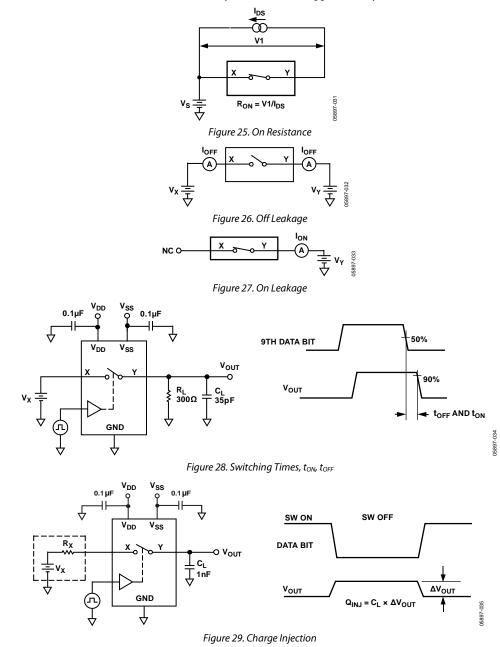


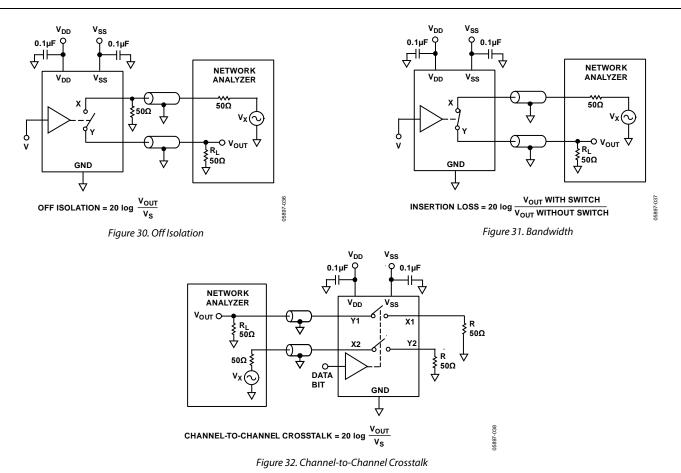
Figure 23. Digital Current (I_L) vs. V_{LOGIC} for Varying Digital Supply Voltage



TEST CIRCUITS

The test circuits show measurements on one channel for clarity, but the circuit applies to any of the switches in the matrix.





TERMINOLOGY

On Resistance (R_{ON}) The series on-channel resistance measured between the X input/output and the Y input/output.

On Resistance Match (ΔR_{ON}) The channel-to-channel matching of on resistance when channels are operated under identical conditions.

On Resistance Flatness (R_{FLAT(ON)}**)** The variation of on resistance over the specified range produced by the specified analog input voltage change with a constant load current.

Channel Off Leakage (IOFF) The sum of leakage currents into or out of an off channel input.

Channel On Leakage (I_{ON}) The current loss/gain through an on-channel resistance, creating a voltage offset across the device.

Input Leakage Current (IIN)

The current flowing into a digital input when a specified low level or high level voltage is applied to that input.

Input Off Capacitance (COFF)

The capacitance between an analog input and ground when the switch channel is off.

Input/Output On Capacitance (Con)

The capacitance between the inputs or outputs and ground when the switch channel is on.

Digital Input Capacitance (C_{IN})

The capacitance between a digital input and ground.

Output On Switching Time (ton)

The time required for the switch channel to close. The time is measured from 50% of the logic input change to the time the output reaches 10% of the final value.

Output Off Switching Time (t_{OFF})

The time required for the switch to open. This time is measured from 50% of the logic input change to the time the output reaches 90% of the switch off condition.

Total Harmonic Distortion + Noise (THD + N)

The ratio of the harmonic amplitudes plus noise of a signal to the fundamental.

-3 dB Bandwidth

The frequency at which the output is attenuated by 3 dB.

Off Isolation

The measure of unwanted signal coupling through an off switch.

Crosstalk

The measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

Differential Gain

The measure of how much color saturation shift occurs when the luminance level changes. Both attenuation and amplification can occur; therefore, the largest amplitude change between any two levels is specified and is expressed as a percentage of the largest chrominance amplitude.

Differential Phase

The measure of how much hue shift occurs when the luminance level changes. It can be a negative or positive value and is expressed in degrees of subcarrier phase.

Charge Injection

The measure of the glitch impulse transferred from the digital input to the analog output during on/off switching.

Input High Voltage (V_{INH}) The minimum input voltage for Logic 1.

Input Low Voltage (V_{INL}) The maximum input voltage for Logic 0.

Output Low Voltage (V_{OL}) The minimum input voltage for Logic 1.

Input Low Voltage (V_{INL}) The maximum output voltage for Logic 0.

I_{DD} Positive supply current.

Iss Negative supply current.

THEORY OF OPERATION

The ADG2188 is an analog cross point switch with an array size of 8×8 . The eight rows are referred to as the X input/output lines, and the eight columns are referred to as the Y input/output lines. The device is fully flexible in that it connects any X line or number of X lines with any Y line when turned on. Similarly, it connects any X line with any number of Y lines when turned on.

Control of the ADG2188 is carried out via an I²C interface. The device can be operated from single supplies of up to 13.2 V or from dual ± 5 V supplies. The ADG2188 has many attractive features, such as the ability to reset all the switches, the ability to update many switches at the same time, and the option of reading back the status of any switch. All of these features are described in more detail here in the Theory of Operation section.

RESET/POWER-ON RESET

The ADG2188 offers the ability to reset all of the 64 switches to the off state. This is done through the RESET pin. When the RESET pin is low, all switches are open (off), and appropriate registers are cleared. Note that the ADG2188 also has a poweron reset block. This ensures that all switches are in the off condition at power-up of the device. In addition, all internal registers are filled with 0s and remain so until a valid write to the ADG2188 takes place.

The digital section of the ADG2188 goes through an initialization phase during the RESET power up. This initialization also occurs after a hardware or software reset. After reset, ensure that a minimum of 200 ns from the time of power-up or reset before any I²Ccommand is issued.

Data Sheet

Ensure that RESET does not drop out during the 200 ns initialization phase because it can result in an incorrect operation of the ADG2188.

Ensure a minimum of 50 ns reset pulse width to achieve a complete reset.

LOAD SWITCH (LDSW)

LDSW is an active high command that allows a number of switches to be simultaneously updated. This is useful in applications where it is important to have synchronous transmission of signals. There are two LDSW modes: the transparent mode and the latched mode.

Transparent Mode

In this mode, the switch position changes after the new word is written into the input shift register. LDSW is set to 1.

Latched Mode

In this mode, the switch positions are not updated at the same time that the input registers are written to. This is achieved by setting LDSW to 0 for each word (apart from the last word) written to the device. Then, setting LDSW to 1 for the last word allows all of the switches in that sequence to be simultaneously updated.

READBACK

Readback of the switch array conditions is also offered when in standard mode and fast mode. Readback enables the user to check the status of the switches of the ADG2188. This is very useful when debugging a system.

SERIAL INTERFACE

The ADG2188 is controlled via an I²C-compatible serial bus. The devices are connected to this bus as a slave device (no clock is generated by the switch).

HIGH SPEED I²C INTERFACE

In addition to standard and full speed I²C, the ADG2188 also supports the high speed (3.4 MHz) I²C interface. Only the –HS models provide this added performance. See the Ordering Guide for details.

SERIAL BUS ADDRESS

The ADG2188 has a 7-bit slave address. The four MSBs are hard coded to 1110, and the three LSBs are determined by the state of Pin A0, Pin A1, and Pin A2. By offering the facility to hardware configure Pin A0, Pin A1, and Pin A2, up to eight of these devices can be connected to a single serial bus.

The 2-wire serial bus protocol operates as follows:

1. The master initiates data transfer by establishing a start condition, defined as when a high-to-low transition on the SDA line occurs while SCL is high. This indicates that an address/data stream follows. All slave peripherals connected to the serial bus respond to the start condition and shift in the next eight bits, consisting of a 7-bit address (MSB first) plus an R/W bit that determines the direction of the data transfer, that is, whether data is written to or read from the slave device.

- 2. The peripheral whose address corresponds to the transmitted address responds by pulling the SDA line low during the ninth clock pulse, known as the acknowledge bit. At this stage, all other devices on the bus remain idle while the selected device waits for data to be written to or read from its serial register. If the R/W bit is 1 (high), the master reads from the slave device. If the R/W bit is 0 (low), the master writes to the slave device.
- 3. Data is transmitted over the serial bus in sequences of nine clock pulses: eight data bits followed by an acknowledge bit from the receiver of the data. Transitions on the SDA line must occur during the low period of the clock signal, SCL, and remain stable during the high period of SCL, because a low-to-high transition when the clock is high can be interpreted as a stop signal.
- 4. When all data bits have been read or written, a stop condition is established by the master. A stop condition is defined as a low-to-high transition on the SDA line while SCL is high. In write mode, the master pulls the SDA line high during the 10th clock pulse to establish a stop condition. In read mode, the master issues a no acknowledge for the ninth clock pulse (that is, the SDA line remains high). The master then brings the SDA line low before the 10th clock pulse and then high during the 10th clock pulse to establish a stop condition.

Refer to Figure 33 and Figure 34 for a graphical explanation of the serial data transfer protocol.

WRITING TO THE ADG2188

INPUT SHIFT REGISTER

The input shift register is 24 bits wide. A 3-byte write is necessary when writing to this register and is done under the control of the serial clock input, SCL. The contents of the three bytes of the input shift register are shown in Figure 33 and described in Table 6.

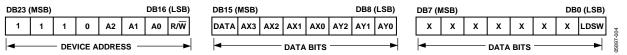


Figure 33. Data-Words

Table 6. Input Shift Register Bit Function Descriptions

| Bit | Mnemonic | Description |
|--------------|------------|---|
| DB23 to DB17 | 1110xxx | The MSBs of the ADG2188 are set to 1110. The LSBs of the address byte are set by the state of the three address pins, Pin A0, Pin A1, and Pin A2. |
| DB16 | R/W | Controls whether the ADG2188 slave device is read from or written to. |
| | | If $R/\overline{W} = 1$, the ADG2188 is being read from. |
| | | If $R/\overline{W} = 0$, the ADG2188 is being written to. |
| DB15 | Data | Controls whether the switch is to be open (off) or closed (on). |
| | | If $Data = 0$, the switch is open/off. |
| | | If Data = 1, the switch is closed/on. |
| DB14 to DB11 | AX3 to AX0 | Controls I/Os X0 to X7. See Table 7 for the decode truth table. |
| DB10 to DB8 | AY2 to AY0 | Controls I/Os Y0 to Y7. See Table 7 for the decode truth table. |
| DB7 to DB1 | Х | Don't care. |
| DB0 | LDSW | This bit is useful when a number of switches need to be updated simultaneously. |
| | | If LDSW = 1, the switch position changes after the new word is read in. |
| | | If LDSW = 0, the input data is latched, but the switch position is not changed. |

As shown in Table 6, Bit DB11 to Bit DB14 control the X input/output lines, while Bit DB8 to Bit DB10 control the Y input/output lines. Table 7 shows the truth table for these bits. Note that the full coding sequence is written out for Channel Y0, and Channel Y1 to Channel Y7 follow a similar pattern. Note also that the RESET pin must be high when writing to the device.

DB13 **DB11 DB15** DB14 **DB12 DB10** DB9 DB8 AY2 **Switch Configuration** DATA AX3 AX2 AX1 AX0 AY1 AY0 X0 to Y0 (on) X0 to Y0 (off) X1 to Y0 (on) X1 to Y0 (off) X2 to Y0 (on) X2 to Y0 (off) X3 to Y0 (on) X3 to Y0 (off) X4 to Y0 (on) X4 to Y0 (off) X5 to Y0 (on) X5 to Y0 (off) Х Reserved Х Reserved X6 to Y0 (on) X6 to Y0 (off) X7 to Y0 (on) X7 to Y0 (off) Х Reserved

Table 7. Address Decode Truth Table

Data Sheet

| DB15 | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | |
|-------|------|-------|-------|------|------|-------|-------|--------------------------------|
| DATA | AX3 | AX2 | AX1 | AX0 | AY2 | AY1 | AY0 | Switch Configuration |
| Х | 1 | 0 | 1 | 1 | 0 | 0 | 0 | Reserved |
| Х | 1 | 1 | 0 | 0 | 0 | 0 | 0 | Reserved |
| Х | 1 | 1 | 0 | 1 | 0 | 0 | 0 | Reserved |
| Х | 1 | 1 | 1 | 0 | 0 | 0 | 0 | Reserved |
| Х | 1 | 1 | 1 | 1 | 0 | 0 | 0 | Reserved |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | X0 to Y1 (on) |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | X0 to Y1 (off) |
| | | | | | | | | |
| 1 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | X7 to Y1 (on) |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | X0 to Y2 (on) |
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | X0 to Y2 (off) |
| | | | | | | | | |
| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | X7 to Y2 (on) |
| 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | X0 to Y3 (on) |
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | X0 to Y3 (off) |
| | | | | | | | | |
| 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | X7 to Y3 (on) |
| 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | X0 to Y4 (on) |
| 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | X0 to Y4 (off) |
| 0 | | - | - | | | | | |
| 1 | | 0 | 0 | | | 0 | 0 | X7 to Y4 (on) |
| 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | X0 to Y5 (on) |
| 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | X0 to Y5 (off) |
| 0 | | - | | | | | | X0 (0 15 (01) |
| 1 | | 0 | 0 | | | 0 | 1 | X7 to Y5 (on) |
| 1 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | X0 to Y6 (on) |
| 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | X0 to Y6 (off) |
| 0 | | - | - | | | | | |
| 1 | | | | | | | | V7 to V6 (on) |
| 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | X7 to Y6 (on) X0 to Y7 (on) |
| 1 | - | - | - | - | | | | |
| 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | X0 to Y7 (off) |
| | | | | | | | | |
| 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | X7 to Y7 (on) |

WRITE OPERATION

When writing to the ADG2188, the user must begin with an address byte and R/W bit, after which the switch acknowledges that it is prepared to receive data by pulling SDA low. This address byte is followed by the two 8-bit words. The write operations for the switch array are shown in Figure 34. Note that it is only the condition of the switch corresponding to the bits in the data bytes that changes state. All other switches retain their previous condition.

READ OPERATION

Readback on the ADG2188 is designed to work as a tool for debug and can output the status of any of the 64 switches of the device. The readback function is a two-step sequence that works as follows:

- Select the relevant X line to be read back from. Note that there are eight switches connecting that X line to the eight Y lines. The next step involves writing to the ADG2188 to tell the device to reveal the status of those eight switches.
 - a. Enter the I²C address of the ADG2188, and set the R/\overline{W} to 0 to indicate a write to the device.

- b. Enter the readback address for the X line of interest, the addresses of which are shown in Table 8. Note that the ADG2188 is expecting a 2-byte write; therefore, be sure to also enter another byte of don't cares (see Figure 35).
- c. The ADG2188 then places the status of those eight switches in a register than can be read back.
- 2. The second step involves reading back from the register that holds the status of the eight switches associated with the X line of choice.
 - a. As before, enter the I²C address of the ADG2188. This time, set the R/\overline{W} to 1 to indicate a read back from the device.
 - d. As with a write to the device, the ADG2188 outputs a 2-byte sequence during readback. Therefore, the first eight bits of data out that are read back are all 0s. The next eight bits of data that come back are the status of the eight Y lines attached to that particular X line. If the bit is a 1, then the switch is closed (on); similarly, if the bit is a 0, the switch is open (off).

The entire read sequence is shown in Figure 35.

| | | | AX2 X AX1 X AX0 X AY2 X AY1 | X AY0 X X 3 | <u> </u> | | | |
|-------------------------------|--------------|---------------------|-----------------------------|---------------------|-----------|---------------------|------------------------------|----------|
| START COND BY MASTER | ADDRESS BYTE | ACK BY SWITCH | DATA BYTE | ACK BY SWITCH | DATA BYTE | ACK BY SWITCH | STOP COND BY MASTER | 5897-005 |
| MAGTER | | | Figure 34. Write Operati | on | | | | 8 |

| X Line | RB7 | RB6 | RB5 | RB4 | RB3 | RB2 | RB1 | RB0 |
|--------|-----|-----|-----|-----|-----|-----|-----|-----|
| X0 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 0 |
| X1 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 0 |
| X2 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 |
| Х3 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 |
| X4 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 1 |
| X5 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 1 |
| X6 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1 |
| Х7 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 |

Table 8. Readback Addresses for Each X Line

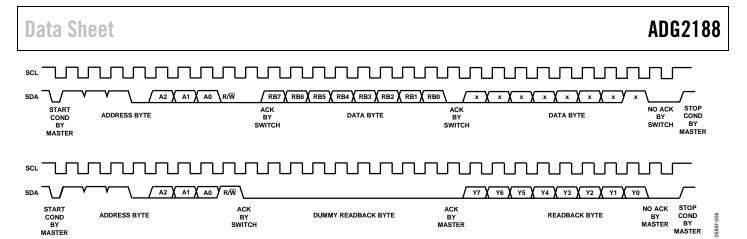


Figure 35. Read Operation

EVALUATION BOARD

The ADG2188 evaluation board allows designers to evaluate the high performance 8×8 switch array of the ADG2188 with a minimum of effort.

The evaluation kit includes a populated, tested ADG2188 printed circuit board. The evaluation board interfaces to the USB port of a PC, or it can be used as a standalone evaluation board. Software is available with the evaluation board that allows the user to easily program the ADG2188 through the USB port. Schematics of the evaluation board are shown in Figure 36 and Figure 37. The software runs on any PC that has Microsoft[®] Windows[®] 2000 or Windows XP installed.

USING THE ADG2188 EVALUATION BOARD

The ADG2188 evaluation kit is a test system designed to simplify the evaluation of the ADG2188. Each input/output of the device comes with a socket specifically chosen for easy audio/video evaluation. An application note is also available with the evaluation board that gives full information on operating the evaluation board.

POWER SUPPLY

The ADG2188 evaluation board can be operated with both single and dual supplies. V_{DD} and V_{SS} are supplied externally by the user. The V_L supply can be applied externally, or the USB port can power the digital circuitry.

Data Sheet

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SCHEMATICS

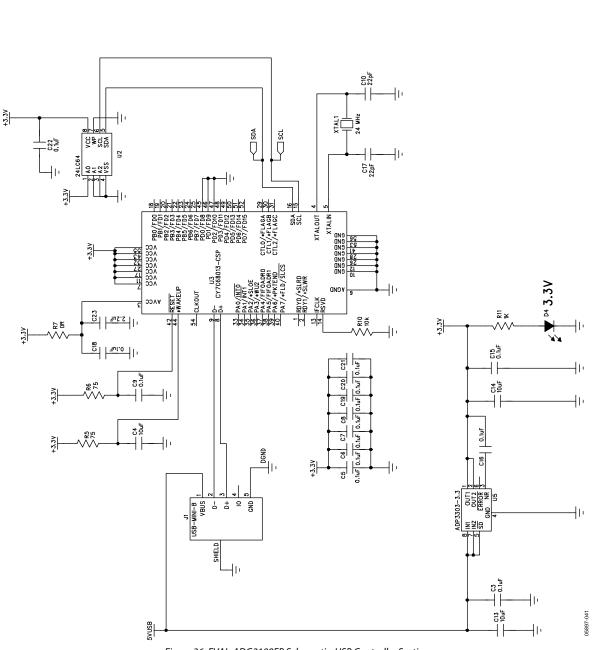


Figure 36. EVAL-ADG2188EB Schematic, USB Controller Section

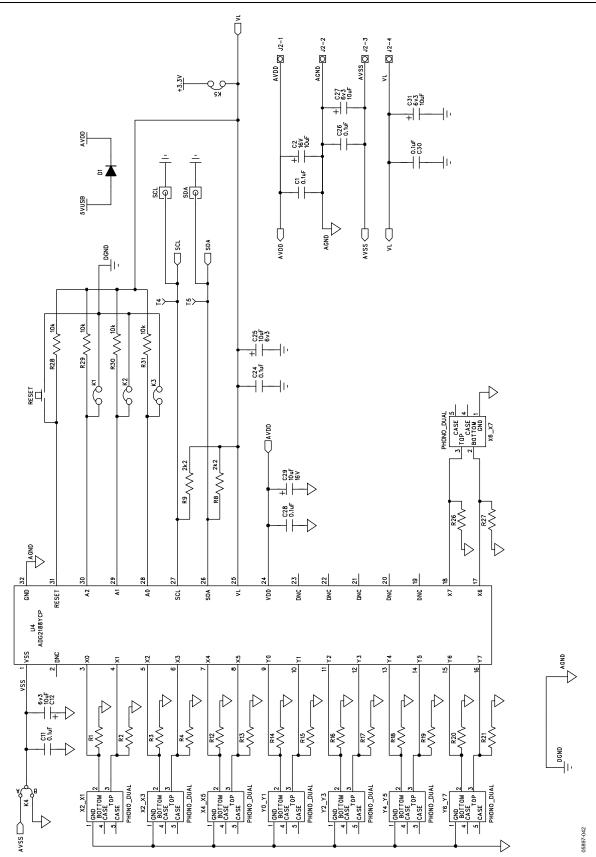
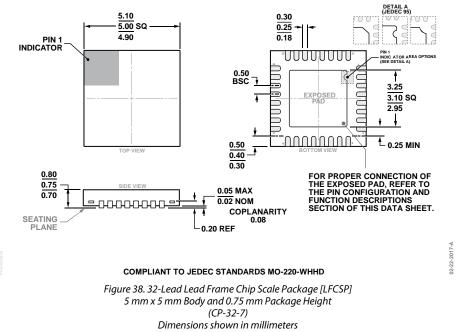


Figure 37. EVAL-ADG2188EB Schematic, Chip Section

OUTLINE DIMENSIONS



ORDERING GUIDE

| Model ^{1, 2} | Temperature Range | l ² C Speed | Package Description | Package Option |
|-----------------------|----------------------|------------------------|---|-------------------|
| ADG2188BCPZ-REEL7 | -40°C to +85°C | 100 kHz, 400 kHz | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-7 |
| ADG2188YCPZ-REEL7 | -40°C to +125°C | 100 kHz, 400 kHz | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-7 |
| ADW54012Z-0REEL7 | -40°C to +85°C | 100 kHz, 400 kHz | 32-Lead Lead Frame Chip Scale Package [LFCSP] | CP-32-7 |
| EVAL-ADG2188EBZ | | | 8 x 8 Evaluation Board | |

 1 Z = RoHS Compliant Part.

² W = Qualified for Automotive Applications.

AUTOMOTIVE PRODUCTS

The ADW54012 model is available with controlled manufacturing to support the quality and reliability requirements of automotive applications. Note that this automotive model may have specifications that differ from the commercial models; therefore, designers should review the Specifications section of this data sheet carefully. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

Data Sheet

NOTES

I²C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

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